



9/6/06

10/723,474

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Suan J. Boon  
Serial No.: 10/723,474  
Filed: November 26, 2003  
Title: ELECTRONIC APPARATUS HAVING AN ADHESIVE LAYER FROM WAFER LEVEL PACKAGING

Examiner: DiLinh Nguyen  
Group Art Unit: 2814  
Docket: 303.601US2

COMMUNICATION CONCERNING RELATED APPLICATION(S)

MS RCE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Applicant would like to bring to the Examiner's attention the following related application(s) in the above-identified patent application:

<u>Serial/Patent No.</u>	<u>Filing Date/Issue Date</u>	<u>Attorney Docket</u>	<u>Title</u>
<i>del</i> 11460089	July 26, 2006	303.601US4	WAFER LEVEL PRE-PACKAGED FLIP CHIP
<i>del</i> 11460093	July 26, 2006	303.601US5	WAFER LEVEL PRE-PACKAGED FLIP CHIP
<i>del</i> 11460435	July 27, 2006	303.601US6	WAFER LEVEL PRE-PACKAGED FLIP CHIP SYSTEMS
<i>del</i> 11460445	July 27, 2006	303.601US7	WAFER LEVEL PRE-PACKAGED FLIP CHIP SYSTEM

Continuations and divisionals may be later filed on the cases listed above, or cited to the Examiner in any previous Communication Concerning Related Applications. Applicants request that the Examiner review all continuations and divisionals of the above-listed or previously-cited patent applications before allowing the claims of the present patent application.

Respectfully submitted,  
SUAN J. BOON  
By Applicant's Representatives,  
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Date AUGUST 31, 2006

By Robert Madden

Robert Madden  
Reg. No. 57,521

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Mail Stop RCE, Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on this 31 day of August 2006.

Name

KATE GARDNER

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Kate G



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Substitute for form 1449A/PTO

**INFORMATION DISCLOSURE  
STATEMENT BY APPLICANT**

(Use as many sheets as necessary)

Complete if Known

Application Number	10/723,474
Filing Date	November 26, 2003
First Named Inventor	Boon, Suan
Group Art Unit	2814
Examiner Name	Nguyen, DiLinh

Sheet 1 of 1

Attorney Docket No: 303.601US2

**US PATENT DOCUMENTS**

Examiner Initial *	USP Document Number	Publication Date	Name of Patentee or Applicant of cited Document	Filing Date If Appropriate
DL	US-5,849,608	12/15/1998	Abe, M.	05/29/1997
	US-6,063,646	05/16/2000	Okuno, A. , et al.	10/06/1998
	US-6,103,552	08/15/2000	Lin, Mou-Shiung	08/10/1998
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	US-6,492,200	12/10/2002	Park, I. S., et al.	05/24/1999
DL	US-6,903,451	06/07/2005	Kim, N. S., et al.	11/27/2000

**FOREIGN PATENT DOCUMENTS**

Examiner Initials *	Foreign Document No	Publication Date	Name of Patentee or Applicant of cited Document	T <sup>2</sup>
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**OTHER DOCUMENTS -- NON PATENT LITERATURE DOCUMENTS**

Examiner Initials *	Cite No <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T <sup>1</sup>
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EXAMINER

*DiLinh Nguyen*

DATE CONSIDERED

*10/13/06*

Substitute Disclosure Statement Form (PTO-1449)

\* EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. <sup>1</sup> Applicant's unique citation designation number (optional). <sup>2</sup> Applicant is to place a check mark here if English language Translation is attached.